



MMIC SURFACE MOUNT

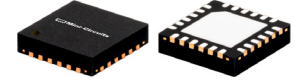
Power Splitter/Combiner

EP2K1+

2 Way-0° 50Ω 2 to 26.5 GHz

THE BIG DEAL

- Ultra-Wide bandwidth, usable over 1.8 to 28 GHz
- High Power Handling, 2.5W as a splitter
- Excellent amplitude unbalance, 0.1 dB typ.
- Good phase unbalance, 1 to 5° typ.
- High ESD level
- Small size, 4x4 mm
- Aqueous washable
- DC passing



Generic photo used for illustration purposes only

CASE STYLE: DG1847

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

APPLICATIONS

- WIMAX
- ISM
- Instrumentation
- Radar
- WLAN
- Satellite communications
- LTE

PRODUCT OVERVIEW

Mini-Circuits EP2K1+ is a MMIC splitter/combiner designed for wideband operation from 2 to 26.5 GHz. This model provides excellent power ratings in a tiny device package (4x4x1 mm), with up to 2.5 W power handling (as a splitter) and up to 1.2A DC current passing. Manufactured using GaAs IPD technology, it provides a high level of ESD protection and excellent reliability.

KEY FEATURES

Feature	Advantages
Wideband, 2 to 26.5 GHz	One power splitter can be used in many applications, saving component count. Also ideal for wideband applications such as military and instrumentation.
Excellent power handling 2.5W as a splitter at 25°C 1.7W internal dissipation as a combiner at 25°C	In power combiner applications, half the power is dissipated internally. EP2K1+ is designed to handle 1.7W internal dissipation as a combiner allowing reliable operation without excessive temperature rise. Similar splitters implemented as Wilkinson splitters on PCB require big resistors and additional heat sinking. As a splitter, EP2K1+ can handle up to 2.5W in a very small package.
DC Passing up to 1.2A	DC current passing is helpful in applications where both RF & DC need to pass through the DUT, such as antenna mounted hardware.
Small size 4 x 4mm QFN package	Tiny footprint saves space in dense layouts while providing low inductance, repeatable transitions, and excellent thermal contact to the PCB.





ELECTRICAL SPECIFICATIONS¹ AT 25°C

Parameter	Frequency (GHz)	Min.	Typ.	Max.	Unit
Frequency Range		2		26.5	GHz
Insertion Loss ² above 3.0 dB	2 - 5	—	0.8	1.3	dB
	5 - 10	—	1.1	1.6	
	10 - 18	—	1.7	2.5	
	18 - 26.5	—	2.4	3.2	
Isolation	2 - 5	6	14	—	dB
	5 - 10	13	22	—	
	10 - 18	14	20	—	
	18 - 26.5	14	21	—	
Phase Unbalance	2 - 5	—	1.5	4	Degree
	5 - 10	—	2.3	6	
	10 - 18	—	3.7	8	
	18 - 26.5	—	5.4	9	
Amplitude Unbalance	2 - 5	—	0.1	0.3	dB
	5 - 10	—	0.1	0.3	
	10 - 18	—	0.1	0.5	
	18 - 26.5	—	0.3	0.7	
VSWR (Port S)	2 - 5	—	1.5	—	:1
	5 - 10	—	1.4	—	
	10 - 18	—	1.4	—	
	18 - 26.5	—	1.4	—	
VSWR (Port 1-2)	2 - 5	—	1.5	—	:1
	5 - 10	—	1.3	—	
	10 - 18	—	1.4	—	
	18 - 26.5	—	1.5	—	

1. Tested on Mini-Circuits Test Board TB-845+

2. Insertion Loss Values are de-embedded from Test Board Loss; 0.3 dB at 2 GHz, 0.5 dB at 5 GHz, 0.8 dB at 10 GHz and 1.3 dB at 18 GHz & 2 dB at 26.5 GHz

MAXIMUM RATINGS

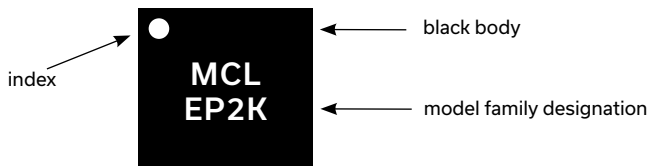
Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-65°C to 150°C
Power Input (as a splitter)	2.5W max. at 25°C. Derate linearly to 1.25W at 85°C
Internal Dissipation	1.7W max. at 25°C. Derate linearly to 1.1W at 85°C
DC Current	1.2A max. at 25°C. Derate linearly to 0.6A at 85°C

Permanent damage may occur if any of these limits are exceeded.

PAD CONNECTIONS

Function	Pad Number
SUM PORT	3
PORT 1	14
PORT 2	17
NOT USED, GROUND EXTERNALLY	1, 2, 4-13, 15-16, 18-24, Paddle

PRODUCT MARKING



Marking may contain other features or characters for internal lot control

SIMPLIFIED ELECTRICAL SCHEMATIC

